

66. Experimental and modeling means for analysis and replication periodical microstructures

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Abstract. Precise microstructures find their application in various areas: laser industry; electronic, microfluidic devices. There are several processes for production of precise periodic microstructures. One of these processes is hot imprint, on the other hand there are many challenges, related with quality of microstructure. One of the solutions for the quality issues is exploitation of ultrasonic excitation during the process of mechanical hot imprint. In the paper analytical measures and analysis algorithms for the measurement of quality parameters of already created microstructure, as well for dynamic analysis of created vibroactive pad are presented. In the end of the paper vibroactive pads are experimentally analysed using already discussed equipment and measuring algorithms, in order to find out their operating frequencies.

Keywords: replication, polycarbonate, ultrasonic hot embossing.

1. Introduction

David Rittenhouse, an American astronomer, made the first periodical microstructure in 1785 [1]. It is reported that the microstructure was half inch-wide. It was not as small as microstructures, created by novel technologies, but this was the beginning of invention. From 1785 periodical microstructure changed in size and manufacturing ways, but the whole concept remained the same. The microstructure is composed from narrow grooves separated by spaces between them, which are in the level of propagating light's wavelength.

Nowadays science is more concerned on micro and nano levels of our surrounding world. Scientists are establishing new ways of using common physical phenomena for achieving new inventions or improving already existing solutions [1-48]. To do so, micro scientific equipment has to be constructed and exploited in order to achieve previously stated objectives.

Scientific equipment used for nano or micro levels of measurements mainly consists of micro-mechanical systems. Furthermore, a periodical microstructure has a great role in these micro-mechanical systems. Periodical microstructures are being used in lasers, sensors, holography, etc.

A periodical microstructure is constructed of narrow grooves separated by spaces between them which are in the level of propagating light's wavelength. With the help of periodical microstructure, the propagating polychromatic light can be separated into its components. Furthermore, the number of components depends on the period of the microstructure and propagating light which can be transmitted or reflected. These components then become the foundation of analysis because transforms in to monochromatic light.

By mentioning nano levels, one can bear in mind very small material and the quality it has to reach to be sufficient in providing good efficiency and worth of the experiment. In order to achieve good quality of periodical microstructures, precise processing regimes have to be maintained throughout the manufacturing of this microstructure.

In this paper experimental techniques, analysis of periodic microstructures and vibroactive pads, whose purpose is improvement the quality of periodical microstructures, created during mechanical hot imprint, of two different constructions are presented.

2. Polycarbonate used for replication of periodical microstructures

The application of polycarbonate (Fig. 1) in replication of periodical microstructures was analyzed by Janušas G. and Naraiuskaite B. in 2013. It is stated that polycarbonate is a suitable material for periodical microstructure's replication because of its physical properties, such as [49]:

- Strength;
- Ability to withstand scratches;
- Easily cleaned;
- Usability in high temperatures.

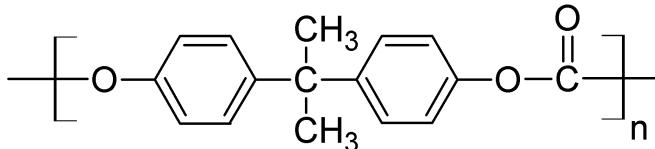


Fig. 1. Chemical formula of polycarbonate

The thermal, chemical and physical properties of polycarbonate are shown in the Table 1-Table 3.

Table 1. Thermal properties of polycarbonate

Melting temperature (T_m)	267°C
Glass transition temperature (T_g)	150°C
Heat deflection temperature – 10 kN	145°C
Heat deflection temperature 0.45 MPa	140°C
Heat deflection temperature – 1.8 MPa	128-138°C
Upper working temperature	115-130°C
Lower working temperature	-40°C
Linear thermal expansion coefficient	$65-70 \times 10^{-6}/K$
Specific heat capacity	1.2-1.3 kJ/(kg·K)
Thermal conductivity 23°C	0.19-0.22 W/(m·K)

Table 2. Chemical properties of polycarbonate

Young's modulus	2.0-2.4 GPa
Tensile strength	55-75 MPa
Compressive strength	>80 MPa
Poisson's ratio	0.37
Coefficient of friction	0.31

Table 3. Physical properties of polycarbonate

Density	1.20-1.22 g/cm ³
Refractive index	1.584-1.586
Water absorption - Equilibrium	0.16-0.35 %
Water absorption – over 24 hours	0.1 %
Light transmittance	88 %

3. No contact holographic measure-system PRISM

By introducing high frequency vibrations in the thermal embossing fabrication method a difficulty of measuring these vibrations occur. Because of very high frequency, the amplitude of these vibrations seeks only the level of micrometers and they are impossible to be seen by naked eye. For measuring this kind of dynamic processes, the most efficient and suitable method is digital holographic interferometry [50, 51].

Kaunas University of Technology has a no-contact holographic measure-system PRISM. This equipment is bought from USA manufacturer HYTEC. The system consists of a control block, illumination head of the object and video camera (Fig. 2).

For analysis, PRISM uses green color light beam (532 nm). The beam from control block through fiber is directed to the lens systems where it is expanded and directed to the object. The supporting beam through fiber goes to video camera where it interferes with registered beam which is reflected from the object. With the help of video camera and control block, the ratio

between object beam and supported beam until the best interference zones, can be seen. The interference view is sent to the computer, where with the help of PRISMA-DAQ software, it is processed. User can see the dynamical processes in the screen (Fig. 3) [41]. The generated view of a dynamical structure can be seen in the Fig. 4.

The specification of holographic measuring system PRISM can be found in Table 4.

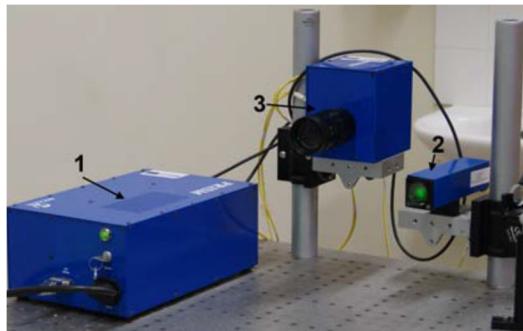


Fig. 2. No contact holographic measure-system PRISM: 1 – control block, 2 – illumination head of object, 3 – video camera [41]

Table 4. Specifications of holographic measuring system PRISM

Measurement Sensitivity	< 20 nm
Dynamic Range	10 μm
Measurement Range	> 100 μm
Largest Part Size	1 meter diameter
Working Distance	> $\frac{1}{4}$ meter
Data Acquisition Rate	30 Hz
Laser	20 mV

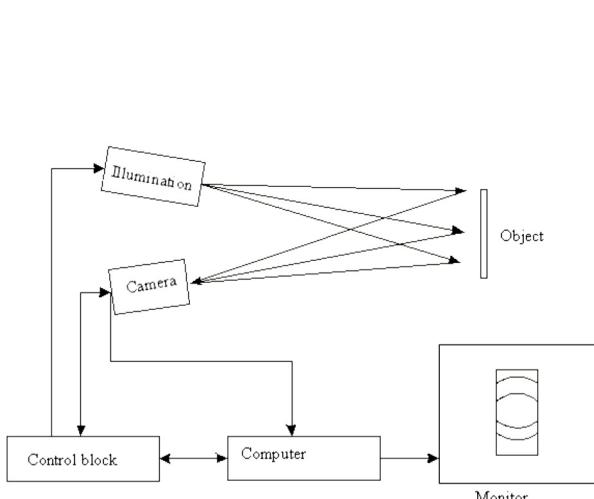


Fig. 3. PRISM system's setup [53]

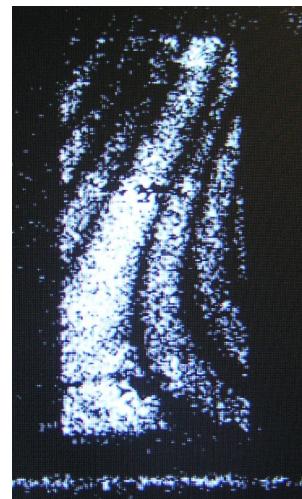


Fig. 4. A hologram of a dynamical structure by 4700 Hz 40 V signal excitation [4]

4. Diffractometer

Optical investigation setup and simplified scheme, used in order to determine diffraction efficiencies are shown in Fig. 5 and Fig. 6, consists of three major parts: sample, photodiode, and ammeter. The laser ($\lambda = 632.8 \text{ nm}$) and photodiode BPW-34 were used in order to measure diffraction efficiency. Scheme is connected to tester.

In order to eliminate material optical properties and evaluate the geometry, the relative diffraction efficiency ($SE_{i,j}$) is calculated by using following formulas:

$$SE_{i,j} = \frac{I_{i,j}}{I_j}, \quad (1)$$

$$I_j = \sum_i I_{i,j}, \quad (2)$$

where $I_{i,j}$ – intensity of diffraction maxima of i th reflection under the j th angle of illumination; I_j – sum of all intensities of diffraction maxima under the j th angle of illumination.

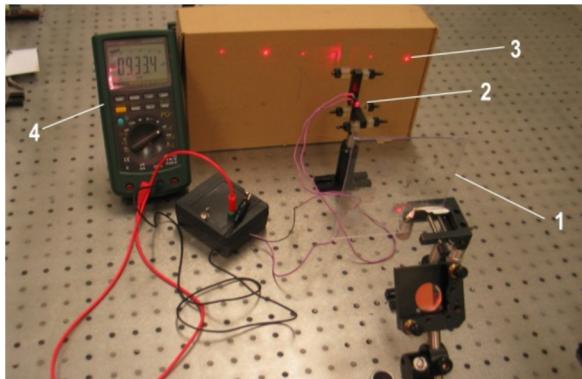


Fig. 5. Measurement of diffraction efficiency: 1 – sample, 2 – photodiode, connected to ammeter, 3 – distribution of diffraction maxima, 4 – ammeter

The current, which passes through photodiode, is being registered by the ammeter. The magnitude of the current is directly proportional to the amounts of photons of the light, which strike the photodiode. According to the Eq. (2), sum (I_j) of all currents (different diffraction angles) is being calculated and then particular current (value of particular maxima) is being divided from this sum and the relative value (%) of diffraction efficiency is thus obtained. The most important indicator in practice, which determines optical quality of the grating, is +1 and -1 maxima. This property (bigger diffraction efficiency value of these maxima) is strongly desirable in various applications [54].

In this Master Thesis the whole replication process with its regimes was analyzed, therefore all of maxima were taken into consideration. By comparing whole array of maxima one can find how well the microstructure is replicated as a whole and not only two maxima points.

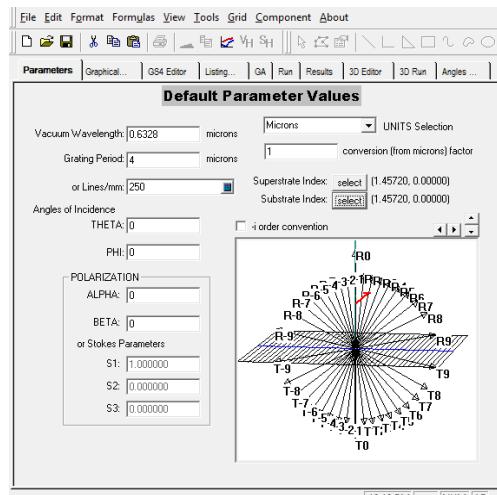


Fig. 7. Main window of GSolver (default parameter window)

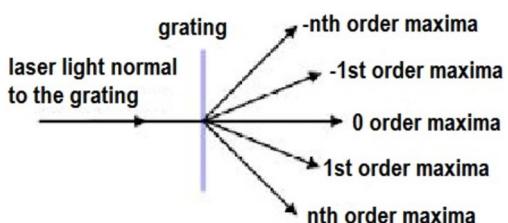


Fig. 6. Simplified scheme of distribution of diffraction maxima

5. GSolver modeling software

GSolver (Fig. 7) was created by Grating Solver Development Company in 1994. This tool has enabled to model transmission and refraction diffraction efficiencies for multilayered, variable thickness, depth and profile geometry periodical microstructures.

The calculation tool for this software is based on modal or coupled-wave method (Fig. 8). The simulation of diffracted electromagnetic wave's fields, phases and diffraction efficiencies from selected microstructure is taken for every layer of the periodical microstructure separately. Afterwards, all the solutions are combined and boundary conditions are introduced [55].

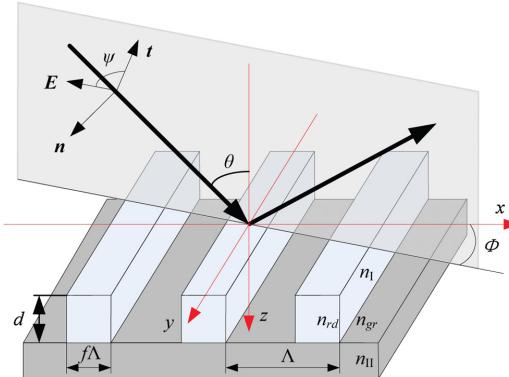


Fig. 8. Periodical microstructure's and propagating light's scheme [56]

RCW (Rigorous Couple-Wave) algorithm is easily adaptable. All the calculations are done only by one period. The periodical microstructure is approximated by layers in the interval $[-d/2; d/2]$ (here, d – the period of a periodical microstructure). During the modeling, it is taken that the ambient of model is homogeneous, linear and isotropic [55, 56].

Maxwell's equation is adapted to this model with boundary and Rayleigh-Jeans radiant law conditions (Eq. (3)):

$$\frac{\partial^2}{\partial z^2} H_{i,y}(x, z) = -k_0^2 \frac{\tilde{\epsilon}_l(x)}{\epsilon_0} H_{i,y}(x, z) - \frac{\tilde{\epsilon}_l(x)}{\epsilon_0} \frac{\partial}{\partial x} \left(\frac{\epsilon_0}{\tilde{\epsilon}_l(x)} \frac{\partial}{\partial x} H_{i,y}(x, z) \right), \quad (3)$$

where, $H_{i,y}(x, z)$ is the incident reflected diffracted and transmitted diffracted fields (depending on the needed solution); $\tilde{\epsilon}_l(x)$ is the dielectric permittivity [55, 56, 57].

The most accurate method is called integral method. It allows analyzing periodical microstructure diffraction efficiencies in all spectral range. Here, the profile, without non approximated Furje series, but which fully defines the real profile of the microstructure is integrated taken in mind the profile changes and the first derivative of the series. With this method, it is possible to calculate diffraction efficiencies, when structures have micro roughness.

Diffraction efficiency is calculated with Eq. (4), like closed surface S^+ Helmholtz – Kirchhoff integral:

$$E^d = \int_{S^+} = \int_{S^+} \Gamma^+(x, y, s') \Phi(s') ds', \quad (4)$$

here, s' – coordinate of the profile, which is equivalent to the rectangular coordinates $[x', f(x')]$ and $\Phi(s') = -i\omega\mu_0 j_e \delta(x - x')\delta(y - f(x'))$, ω - cyclic frequency, μ_0 – vacuum permeability, j_e – current in S profile lengths unit in XY plane, perpendicular to this profile, Dirac delta function $\delta(x - x')\delta(y - f(x'))$ is equal to one, when $x = x'$ and $y = f(x')$, other times, it is equal to

zero, $\Gamma^+[x, y, s']$ – solution of Helmholtz inequality [58].

Integration through profile S can be replaced by integration through one period when the incident wave's quasi-periodicity is assessed. Then, Eq. (4) can be rewritten as infinite integral sum. Here, the Gryn's functions can be defined as consistent expansions of plane wave:

$$\Gamma^+(x, y, s') = \frac{1}{2id} \sum_{-\infty}^{\infty} e^{\frac{i\alpha(x-x')+i\gamma_n^+|y-f(x')|}{\gamma_n^+}}, \quad (5)$$

here, $K = 2\pi/d$, $\alpha_n = nK + \alpha_0$, $\alpha_0 = k^+ \sin(\theta)$, and $\gamma_n^+ = \sqrt{(k^+)^2 - \alpha_n^2}$, y – vector component of the wave, $f(x)$ – function, which defines surface on plane XZ , d – period of microstructure, θ – angle of irradiance (in respect of OY axis), h – depth of microstructure, n – surface normal vector. With this method, integration of only one period segment compiles to integration of whole surface S [58].

6. Ultrasonic thermal embossing setup

To understand the whole ultrasonic thermal embossing process, step by step procedure has to be known. This procedure can be found in the following list:

- 1) Preheating of plate with master mold;
- 2) Pressing a rigid mould with the required pattern of features into the softened material. Here the pattern is negative. At the same moment the vibroactive pad is generating high frequency vibrations;
- 3) When the heating plate reaches the softened material it presses down for 0.5 s, till the pressure reaches nominal value and later nominal pressure is held for required time;
- 4) Releasing the mold.

In Fig. 9 the schematic diagram of ultrasonic thermal embossing can be seen.

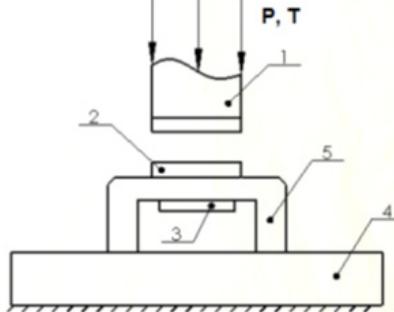


Fig. 9. The schematic diagram of ultrasonic thermal embossing: 1 – the head of the press; 2 – formable material (polycarbonate); 3 – the piezoelectric material; 4 – the base of the tool; 5 – the vibrating platform [41]

The piezoelectric material excites high frequency vibrations which with the help of aluminum vibrating platform are being transferred to the polycarbonate. The piezoelectric material and vibrating platform makes one element – vibroactive pad.

7. Master periodical microstructure

In this work, the replicas of periodical microstructures will be analyzed. In order to fabricate these replicas, the master periodical microstructure is required. By using the master periodical microstructure, it is possible to fabricate all the replicas with the desired process regimes.

The master microstructure used in this work was made of Nickel. It had 4 μm period (the land

and the ridge are equal – 2 μm) and 300 μm depth (Fig. 10).

The realistic view of a master microstructure can be seen in Fig. 11. The picture was made with atomic force microscope.

Master microstructure was used not only for fabrication of microstructure replicas but also for analyzing what diffraction efficiencies could be obtained having an ideal replica. With the help of GSolver software, the ideal replica was modeled and all fabricated replicas were compared to these results.

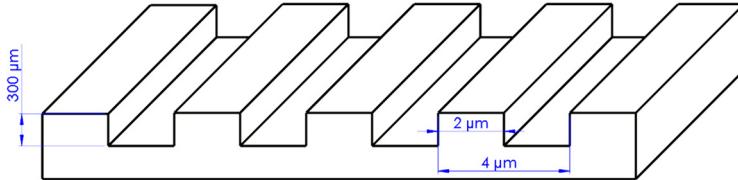


Fig. 10. Schematic drawing of master periodical microstructure

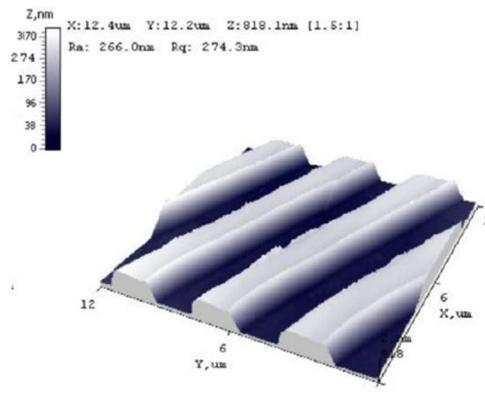


Fig. 11. The view of master periodical microstructure done with atomic force microscope

Table 5. Properties of PZT-4 material

General	
Density (10^3 kg/m^3)	7.5
Curie temperature (K)	601
Elastic constants	
c_{11}^E (GPa)	139
c_{33}^E (GPa)	115
c_{12}^E (GPa)	77.8
c_{13}^E (GPa)	74.3
c_{44}^E (GPa)	25.6
c_{66}^E (GPa)	30.6
Piezoelectric constants	
e_{31} (C/m^2)	-5.2
e_{33} (C/m^2)	15.1
e_{15} (C/m^2)	12.7
Dielectric constants	
ε_{11}^T (10^{-9} F/m)	6.461
ε_{33}^T (10^{-9} F/m)	5.620

8. Vibroactive pad and replication process regimes

It has been shown, that thermal embossing replication provides low quality periodical microstructures [26, 28-29]. To eliminate these faults high frequency vibrations created by a vibrating pad are introduced in the replication process.

In 2013 Kaunas University of Technology team constructed the vibrating pad to excite the high frequency vibrations to the polycarbonate in order to increase the quality of periodical microstructures. The vibrating pad or vibroactive pad is made of aluminum cylinder and a ring of piezoelectric material. The piezoelectric material is excited to produce a vibrational response. The piezoelectric element selected was PZT-4. Its properties are shown in Table 5.

The created vibrating platform was selected to have cylinder geometry with dimensions as following: 50 mm external diameter ring; 20 mm internal diameter and 2 mm thickness (Fig. 12). It was made of aluminum.

The technical drawing of the vibrating platform can be seen in the Fig. 13.

In 2014, the vibroactive pad was improved. This generation of vibroactive pad has a stack type piezoactuator instead of piezoelectric ring. A stack type piezoactuator model PSt 150/4/20 VS9 (Fig. 14) was chosen, because of actuator that is able to generate vibrations of higher amplitude. The technical drawing of this vibroactive pad can be seen in Fig. 15. From the technical drawing

one can see that the thickness of vibrating platform is 1 mm.

The 1st generation vibroactive pad and the 2nd generation vibroactive pad in real life form can be seen in Fig. 16.



Fig. 12. The 3D view of the vibration platform (A) and the vibration platform (1) with the piezoelectric element (2) attached [41]

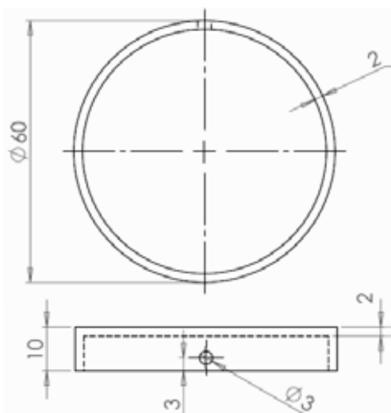


Fig. 13. The drawing of the vibration platform



Fig. 14. Stack type piezoactuator PSt 150/4/20 VS9

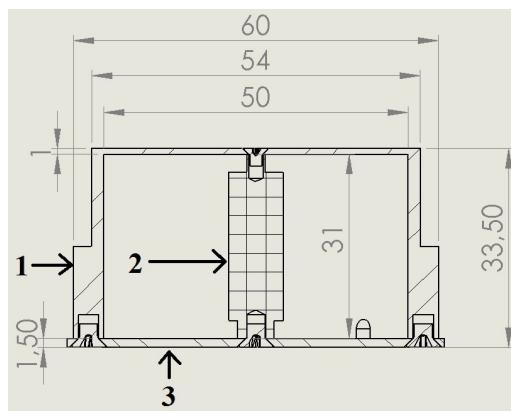


Fig. 15. Drawing of vibroactive pad (1 – upper part of aluminum frame; 2 – low frequency stack type piezoactuator; 3 – bottom part of aluminum frame) [59]

In previous works by Kaunas University of Technology team and scientists worldwide it was shown that the high frequency vibrations improve the quality of periodical microstructure replicas. The aim of this Master Thesis is to analyze how different process regimes with the help of high frequency vibrations improve the quality.

In the experiment both vibroactive pads (1st and 2nd generation) were used. They excited two forms of vibrations (Fig. 17-20). All other process parameters can be seen in the Table 6.

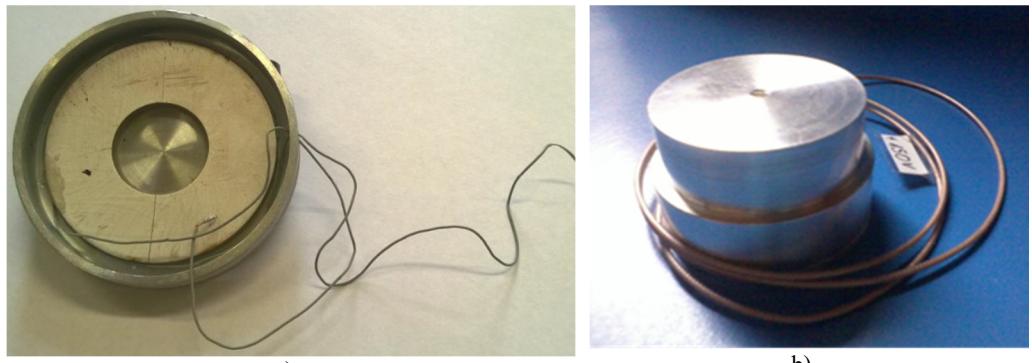


Fig. 16. Manufactured vibroactive pads: a) 1st generation, with piezoelectric ring;
b) 2nd generation, with stack type piezoactuator [59]

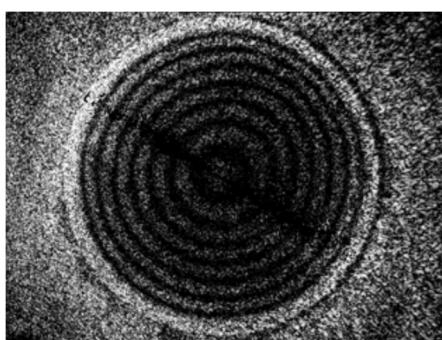


Fig. 17. 1st vibration form of 1st generation vibroactive pad ($f = 5.2$ kHz; $U = 5$ V)

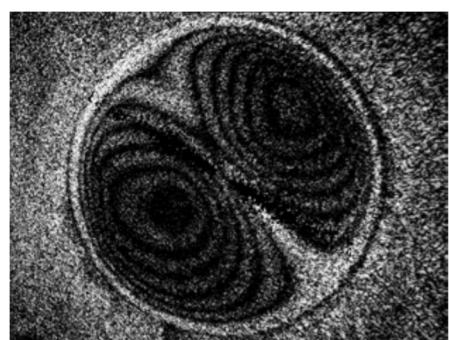


Fig. 18. 2nd vibration mode of 2nd generation vibroactive pad ($f = 8.8$ kHz; $U = 40$ V)

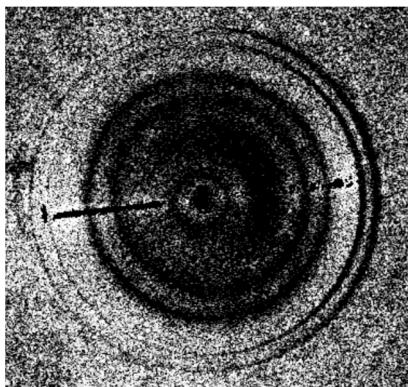


Fig. 19. 1st vibration mode of 2nd generation vibroactive pad ($f = 12.910$ kHz; $U = 3.5676$ V)

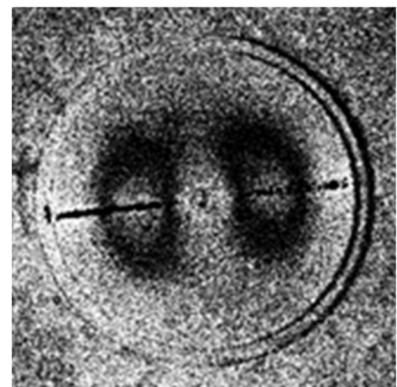


Fig. 20. 2nd vibration mode of 2nd generation vibroactive pad ($f = 13.601$ kHz; $U = 4.4416$ V)

Table 6. Periodical microstructure replication process regimes

Vibrations	Pressure	Temperature	Time
No vibrations	0.1 MPa		
1st form of vibrations ($f = 12.910$ kHz; $U = 3.5676$ V)	0.2 MPa		
2nd form of vibrations ($f = 13.601$ kHz; $U = 4.4416$ V)	0.3 MPa	148°C	5 s
	0.4 MPa	152°C	10 s
	0.5 MPa		15 s
	0.6 MPa		

All replication process parameters were used for replication of periodical microstructures in random order. 49 periodical microstructure replicas were made with the 1st generation vibroactive pad and 20 – with the 2nd generation vibroactive pad.

9. Conclusions

In the paper investigation techniques, which are necessary for investigation of outcomes of ultrasonic hot embossing process as well for dynamic analysis of vibroactive pad, which is employed during the imprint process are presented with all the specifications and discussed.

During the dynamic analysis of two different vibroactive pads performed with PRISM system was revealed, that first and second vibration modes of first generation vibroactive pad are at following parameters respectively: $f = 5.2 \text{ kHz}$; $U = 5 \text{ V}$ and $f = 8.8 \text{ kHz}$; $U = 40 \text{ V}$. Whereas first and second vibration modes of second generation vibroactive pad, based on stack type multilayer actuator are as following: $f = 12.910 \text{ kHz}$; $U = 3.5676 \text{ V}$ and $f = 13.601 \text{ kHz}$; $U = 4.4416 \text{ V}$.

Acknowledgements

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